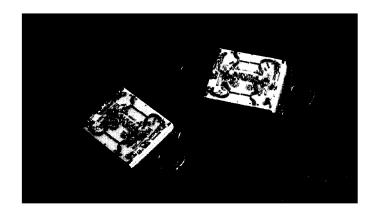
0.5 to 20.0 GHz Microwave Gain Modules

□ Frequency Coverage:

0.5-4 GHz 2-6 GHz 2-8 GHz 2-18 GHz 6-18 GHz 2-20 GHz

- ☐ MIC & MMIC Gain Modules on Kovar Carriers
- ☐ Small Carrier Sizes: 0.560 in. x 0.246 in. 0.680 in. x 0.328 in.
- ☐ Suitable for Military and Commercial Applications



Model	Frequency Response (GHz) Min	Gain (dB) Min	Gain Flatness vs Frequency (±dB) Max	Gain Temperature Coefficient Per 1°C (1) (dB)	Noise Figure (dB)	Power Out- put for 1dB Compression (+dBm)	Input DC current (mA) Typ	Carrier Type (2)
CGM-04-2001	2-4	13.0	0.5	-0.011	1.8	10.0	60	1006
CGM-06-2001 CGM-06-2002 CGM-06-2003	2-6 2-6 2-6	11.5 12.0 12.5	0.5 5 dB Slope ⁽⁵⁾ 0.5	-0.011 -0.011 -0.011	5.5 2.5 4.5	19.0 14.0 16.0	80 80 70	1006-P (-N 1006-P 1006-P (-N
CGM-08-2001 CGM-08-2002 CGM-08-2003 CGM-08-2004 CGM-08-2005	2-8 2-8	8.0 9.5 10.0 10.5 12.0	0.5 0.5 0.5 0.5 5 dB Slope ⁽⁵⁾	-0.011 -0.011 -0.011 -0.011 -0.011	7.5 6.5 6.0 5.0 2.5	24.0 22.0 19.0 16.0 14.0	320 200 80 70 80	1006-P (-N 1006-P (-N 1006-P (-N 1006-P (-N 1006-P
CGM-08-4001	4-8	12.0	0.5	-0.011	1.8	10.0	60	1006
CGM-10-8001	(6) 8-10	12.0	0.25	-0.011	1.9	10.0	60	1248-P (-N
CGM-18-2001 CGM-18-2002 CGM-18-2003 CGM-18-2004 CGM-18-2005 CGM-18-2006	2-18 2-18 2-18	7.5 9.0 10.0 15.0 15.0 15.0	1.0 0.8 0.8 0.75 1.0 1.0	-0.011 -0.022 -0.022 -0.022 -0.022 -0.022	5.0 11.0 9.5 9.0 5.0 8.0	11.0 18.0 15.0 12.0 11.0 11.0	60 330 220 120 120 120	1248 1248 1248 1248 1248 1248
CGM-18-6001 CGM-18-6002 CGM-18-6003 CGM-18-6004 CGM-18-6005 CGM-18-6006 CGM-18-6007 CGM-18-6008	6-18 6-18 6-18 6-18 6-18	4.0 5.0 5.5 5.5 6.0 7.0 7.0	0.8 0.6 0.6 0.5 0.5 0.5 3 dB Slope ⁽⁵⁾	-0.011 -0.011 -0.011 -0.011 -0.011 -0.011 -0.015	N/A 9.5 8.0 6.5 5.8 5.2 7.0	28.0 25.0 22.0 18.0 16.0 14.0 14.0	640 320 200 80 70 70 80 100	1248-P (-1 1248-P (-1 1248-P (-1 1248-P (-1 1248-P (-1 1248-P (-1 1248-P (-1 1248-P (-1
CGM-20-2001 CGM-20-2002 CGM-20-2003 CGM-20-2004	(4) 2-20 (4) 2-20 (4) 2-20	8.0 6.0 12.0 14.0	1.0 1.0 1.5 1.5	-0.012 -0.012 -0.024 -0.024	8.0 6.0 7.0 7.5	22.0 16.0 15.0 20.0	250 100 100 350	1248 1248 1248 1248

NOTES:

- -N on the end of the Model Number.
- 3. Dual gate GaAs FET.
- 4. MMIC chip on MIC circuit.
- 5. Negative slope from low to high frequency.
- 6. Specification over any 500 MHz bandwidth.



^{1.} Gain will increase with decreasing temperature and decrease with increasing temperature.

^{2.} Some circuits are supplied with a positive (-P) or negative (-N) configuration. See package Outlines. When ordering, include a -P or

0.5 to 20.0 GHz Microwave Gain Modules

QUALITY AND RELIABILITY

Celeritek's MIL-I-45208 inspection system and MIL-Q-9858A quality assurance program establishes and maintains product standards and workmanship practices. All modules are burned-in for 48 hours at +85°C to insure reliability. When these modules are properly sealed in a hermetic enclosure, they are capable of meeting the screening and testing requirements of MIL-STD-883. These modules are designed and constructed to meet the testing required by MIL-E-5400 and MIL-E-16400 specifications.

GUARANTEED SPECIFICATIONS

Module specifications are guaranteed at +25°C as shown in the table on the front side of this data sheet. The amplifiers are designed to operate over full military environments when they are installed in hermetic enclosures. Typical gain shifts for each module are listed in the typical data. Typically, noise figures at high temperatures will increase 1/2 to 1 dB and output power will drop by 1 dB.

TESTING/DATA

Celeritek's gain modules are 100% tested at +25°C

and test data will be supplied as follows:

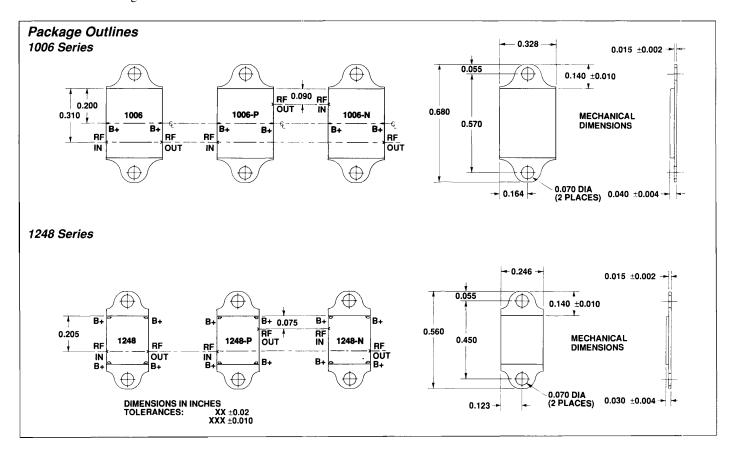
- Swept Gain Plot
- Noise Figure at 5 Frequencies
- Po⁻¹ dB at 5 Frequencies
- Swept VSWR, In and Out

SHIPPING AND HANDLING

Each gain module is shipped in an individual static resistant, plastic see-through case. This allows the part to be physically examined before the seal is broken and the unit removed. All modules should be stored in a dry nitrogen environment prior to and/or after they are removed from their shipping cases. All amplifiers should be properly mounted to ensure adequate heat sinking during operation.

INSTALLATION

All modules are provided on carriers which are mounted using two 0-80 screws. Care must be taken to ensure the mounting surface is flat to ± 0.001 inch with no strips >0.0005 inches. Detailed dimensions of bonding pad locations and bonding recommendations will be supplied with each module. Advanced copies are available.



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